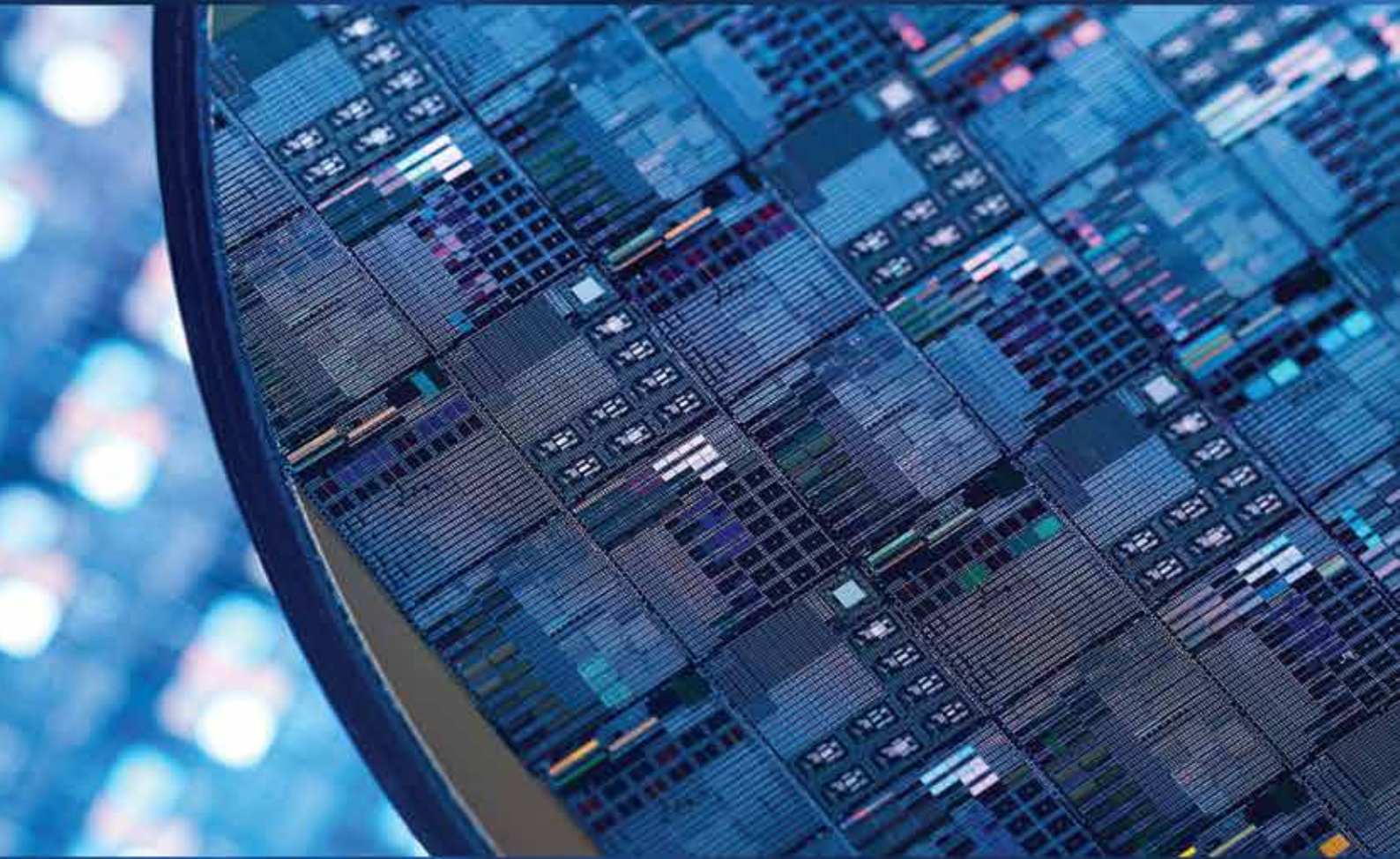




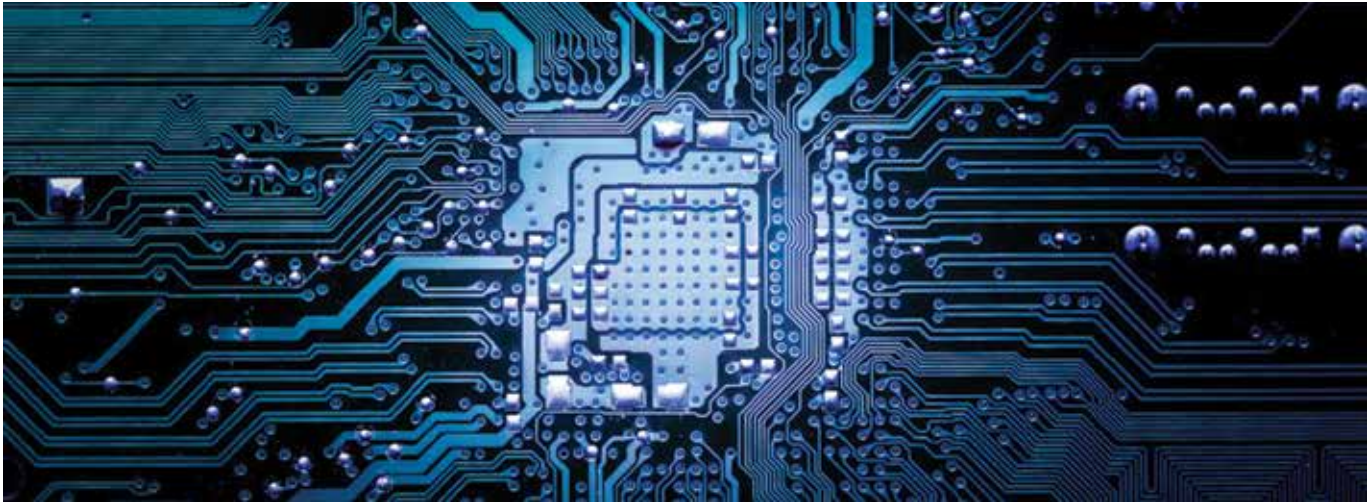
Semiconductor Backend Tools Catalog



2022



AT A GLANCE



Oricus Semicon Solutions is an innovative Semiconductor Tools manufacturing company who, with almost 100 years of collective expertise, craft high tech bespoke tooling solutions for the global Semiconductor Assembly and Test industry.

From one-off customised products to large scale production, our R&D strength, precision manufacturing experience and problem-solving capabilities are impeccable. With a passion for engineering and customer oriented service, we deliver price competitive precision Semiconductor Tooling solutions to a global market with a local presence.

Oricus is made up of a global network of professionals with strong commitment and passion for our work. The company is managed and operated with a spirit of professionalism based on the foundation of integrity, equality and respect. We are determined, objective with a sense of ownership to deliver on our goals. We value our values, professionalism, passion, perseverance and our relentless pursuit to deliver value for our customers.



Authenticity



Expertise



Professionalism



Perseverance



Passion



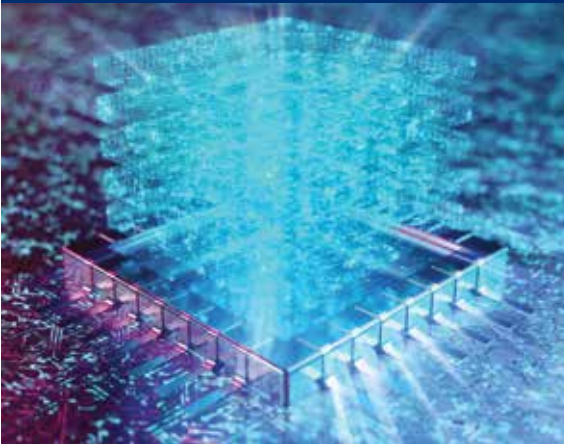
Community

Oriented to Customer's needs



We excel at creating specials – one of a kind pieces, with one of a kind craftsmanship combining with the latest in manufacturing technology to produce micro precision tooling. Oricus can Design and Manufacture either one-offs or high volume orders to your unique specifications, from High Temperature resistant tools for Power Devices to tools with complex geometries for 3D Advanced Packaging.

Industry Leading Solutions



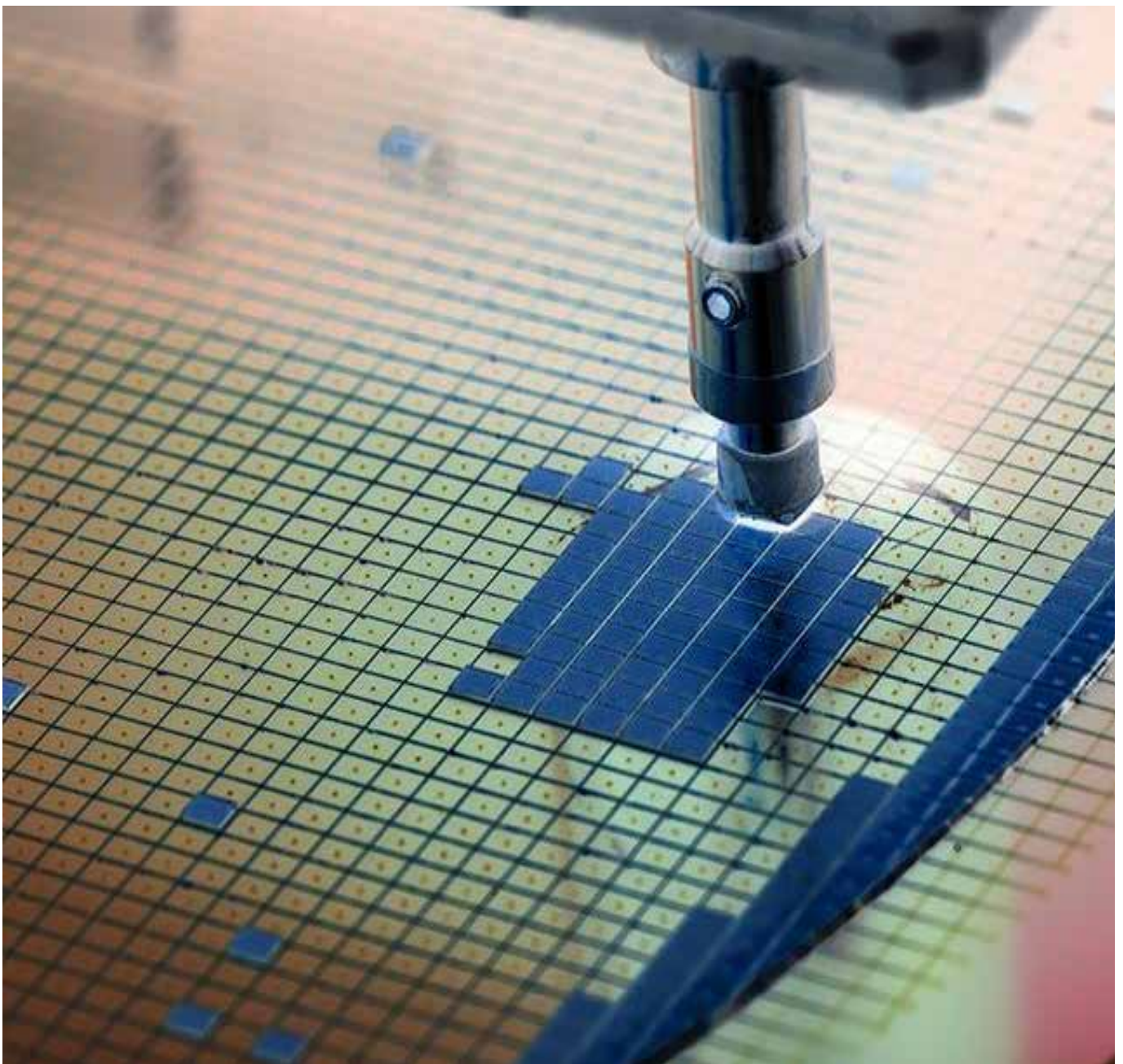
Our Technical Sales Consultants and R&D teams of seasoned Semiconductor Assembly and Test industry professionals will study your chip and package requirements and offer effective and competitive tooling solutions that will work right out of the box. Oricus has the solution to your tooling requirements. Leave it to us and you can focus on your key processes.

Research and Development



R&D is the cornerstone of our commitment to deliver market leading tooling solutions. Our Material Science know-how, coupled with our Manufacturing Expertise and knowledge on the latest demands of Integrated Circuits Packaging allow us to offer tools that maximizes productivity and minimizes downtime.

Die Attach

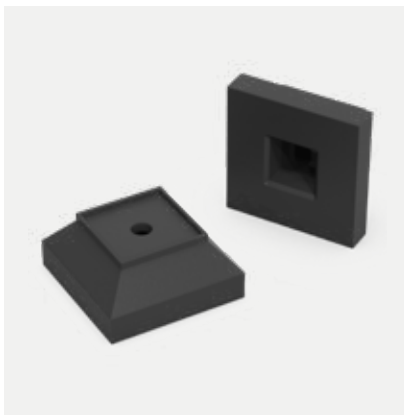


Rubber Tips



Flat Tips

Single central or offset vacuum hole drilled on a flat contact surface, controlled to stringent flatness tolerances.



Vacuum Relief Tips

Designed to steer clear profiles or protrusions on your dies and devices, with a reservoir recess to enhance vacuum suction.



Groove Tips

Features central and branched vacuum grooves on the tip surface that enhances distributed suction force coverage.



Matrix Tips

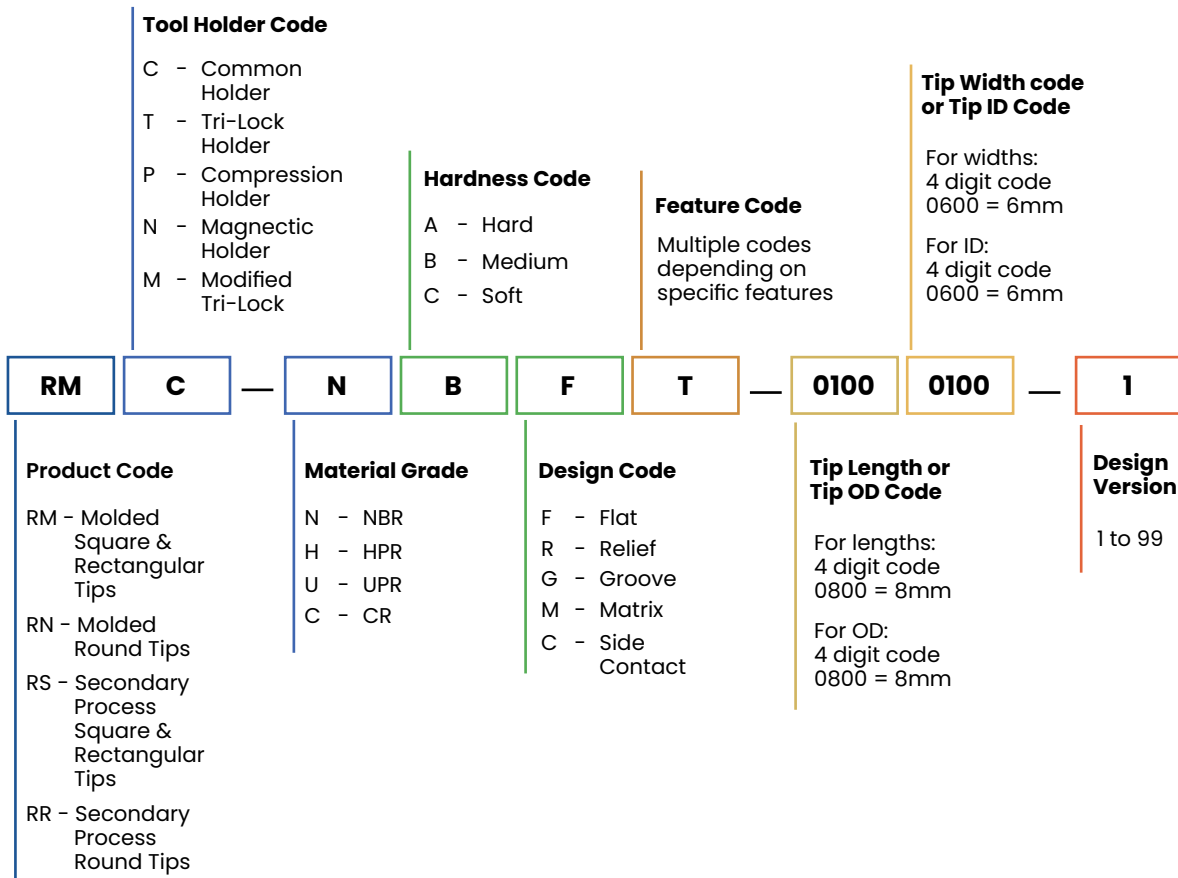
Full Tungsten Carbide Tips with Vacuum holes drilled in a distributed matrix layout. Offers superior surface contact and stable suction pressure.



Side Contact Tips

Engineered with precisely calculated tapered contact angles to grip specific edges of your die to avoid contact of critical areas.

Part Numbers And Ordering

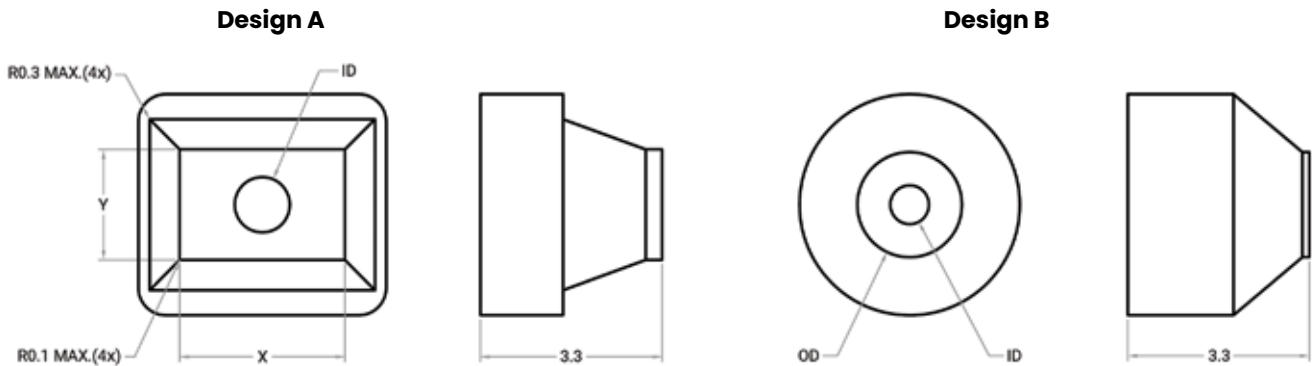


Flat Tips



Rubber Flat Tip designs are versatile rubber tips that are suitable for a wide range of applications. Flat Tip designs feature a single vacuum hole and a flat contact surface controlled to stringent flatness tolerances.

Oricus manufactures an extensive range of standard Rubber Flat Tip sizes with central and offset vacuum hole configurations in various sizes. Customized Flat Tip designs with micro thin walls can also be produced for special applications.



Features

- Direct contact to the face of the die or device
- Suitable for use with our Common, Tri-Lock, Compression and Magnetic Holders
- Available in NBR, HPR, UPR and CR Rubber Materials
- 50-90 Shore A Hardness levels to cater to a wide range of different applications
- E6-E9 Static Dissipative properties to ensure proper Electrostatic Discharge
- Can be made in Round, Square, Rectangular and Custom outer profiles

Benefits

- Cost effective solution that offers superior Cost-Per-Part
- Universal design that is suitable for a wide range of dies sizes and thicknesses
- Offers structural support to the die or device, allowing for minimal flex to during the Pick and Place process.
- Flat surface allows for uniform bond force to be applied throughout the tip face, reducing the probability of voids in the adhesive or DAF

Part Number	X or OD (mm)	Y (mm)	ID (mm)	Design
RMC-NBFT-00890038-1	0.89	0.38	0.2	A
RMC-NBFT-01000100-1	1.00	1.00	0.4	A
RMC-NBFT-01130075-1	1.13	0.75	0.4	A
RMC-NBFT-01400114-1	1.40	1.14	0.5	A
RMC-NBFT-01520152-1	1.52	1.52	0.9	A
RMC-NBFT-01750175-1	1.75	1.75	0.7	A
RMC-NBFT-01780102-1	1.78	1.02	0.4	A
RMC-NBFT-01880125-1	1.88	1.25	0.7	A
RMC-NBFT-02000200-1	2.00	2.00	1.0	A
RMC-NBFT-02500200-1	2.50	2.00	1.0	A
RMC-NBFT-03050152-1	3.05	1.52	0.9	A
RMC-NBFT-03130250-1	3.13	2.50	1.0	A
RMC-NBFT-03750300-1	3.75	3.00	1.0	A
RMC-NBFT-04500450-1	4.50	4.50	1.0	A
RMC-NBFT-05000500-1	5.00	5.00	1.0	A
RNC-NBFT-00210013-1	0.21	-	0.13	B
RNC-NBFT-00300020-1	0.30	-	0.2	B
RNC-NBFT-00380015-1	0.38	-	0.15	B
RNC-NBFT-00400030-1	0.40	-	0.3	B
RNC-NBFT-00510030-1	0.51	-	0.3	B
RNC-NBFT-00630040-1	0.63	-	0.4	B
RNC-NBFT-00750040-1	0.75	-	0.4	B
RNC-NBFT-01000050-1	1.00	-	0.5	B
RNC-NBFT-01250060-1	1.25	-	0.6	B

ESD Properties

Static Dissipative $\geq 10^5$ to $10^9 \Omega$

Applications

Standard Die Attach
Flip Chip
2.5D/3D
Wafer Level Packaging
Panel Level Packaging
System in a Package

Tip Material

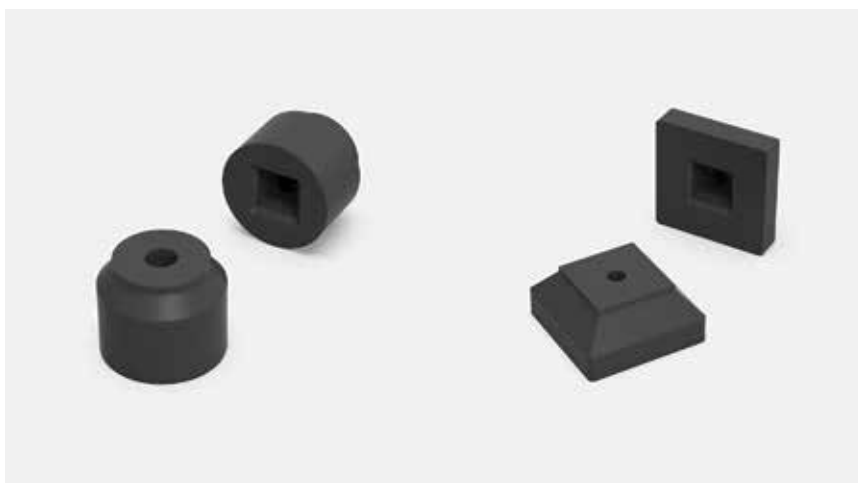
NBR
HPR
UPR
CR

Outer Profiles

Round
Square
Rectangular
Custom

Rubber Holder Compatibility

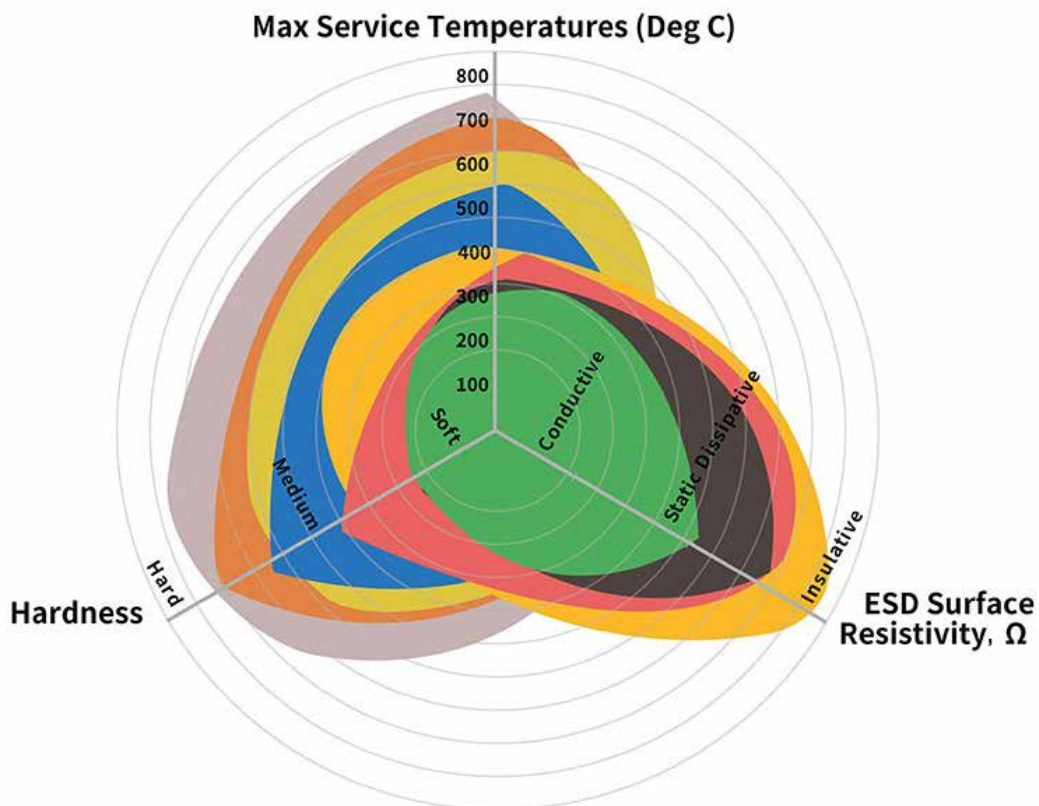
Common Holders
Tri-Lock Holders
Compression Holders
Magnetic Holders
Spring-Loaded Holders



MATERIALS

Oricus's extensive line of engineered materials specially developed and selected to offer optimal tooling performance for your specific Semiconductor Backend process. Our in-house materials are closely developed in partnership with Original Equipment Manufacturers with input from our customers. For externally procured materials, each material goes through a rigorous Quality Assurance and Performance Assessment programme before making it into our material list.

Oricus' in depth understanding and experience of materials allows us to formulate tooling solutions that work for you. As part of our value proposition, we study the conditions of your application and suggest the most appropriate material that meets your needs.



Tungsten Carbide WC Line

Superalloy SA Line

Stainless Steel SS Line

Tool Steel TS Line

Non Ferrous Metals NF Line

Performance Engineering Plastics SP Line

Engineering Plastics EP Line

Rubber R Line

<p>WC LINE</p> <p>Tungsten Carbide</p> <p>High Wear & High Temp Resistance</p> <ul style="list-style-type: none"> Carbide, K15 Carbide, K30 Carbide, M30 Carbide K40 Carbide, MG30 	<p>SA LINE</p> <p>Superalloy</p> <p>All-Round Superior Performance</p> <ul style="list-style-type: none"> Haynes 25 (L605) Inconel Alloy 625 Inconel Alloy 718 Incoloy Alloy 925 Nitronic 50 Nitronic 60 Titanium Grade 2 Stellite 6 Stellite 31 	<p>SS LINE</p> <p>Stainless Steel</p> <p>Balanced Properties</p> <ul style="list-style-type: none"> 15-5 PH 17-4PH SUS 430F SUS 420 SUS 440C SUS 316 SUS 301 SUS 304 SUS 303 	<p>TS LINE</p> <p>Tool Steel</p> <p>High Strength</p> <ul style="list-style-type: none"> CPM-10V SKD 11 SKH 51 Mirrax 40 ASP 23 Stavax XW 10 XW 42 Assab 718 - HH HSS DF2 DF3 Ramax HH Rochling 2315
<p>NF LINE</p> <p>Non Ferrous Metals</p> <p>Special Applications</p> <ul style="list-style-type: none"> Aluminium 7075 Aluminium 6061 Copper Brass Hovadur K350 	<p>SP LINE</p> <p>Performance Engineering Plastics</p> <p>Advantageous Performance & Value</p> <ul style="list-style-type: none"> Torlon 4432 (PAI) Torlon 4301 (PAI) Torlon 5030 (PAI) Torlon 7130 (PAI) Vespel SCP5050 (P) Vespel SP 21 (PD) Vespel SP1 (PI) ESD Semitron 520 ESD Semitron 420 ESD Semitron 410C ESD Semitron 225 	<p>EP LINE</p> <p>Engineering Plastics</p> <p>Economical And Versatile</p> <ul style="list-style-type: none"> Acrylic/ Polycarbonate TECAFORM SD Delrin ESD Delrin White Delrin Black POM PEEK PEEK HT PEEK GF 30% PEEK CF 30% 	<p>R LINE</p> <p>Rubber</p> <p>Geometric Flexibility ESD Protection</p> <ul style="list-style-type: none"> NBR NBR (Soft) NBR (Hard) NBR (Coated) HPR HPR (Soft) HPR (Hard) UPR CR (ESD) CR

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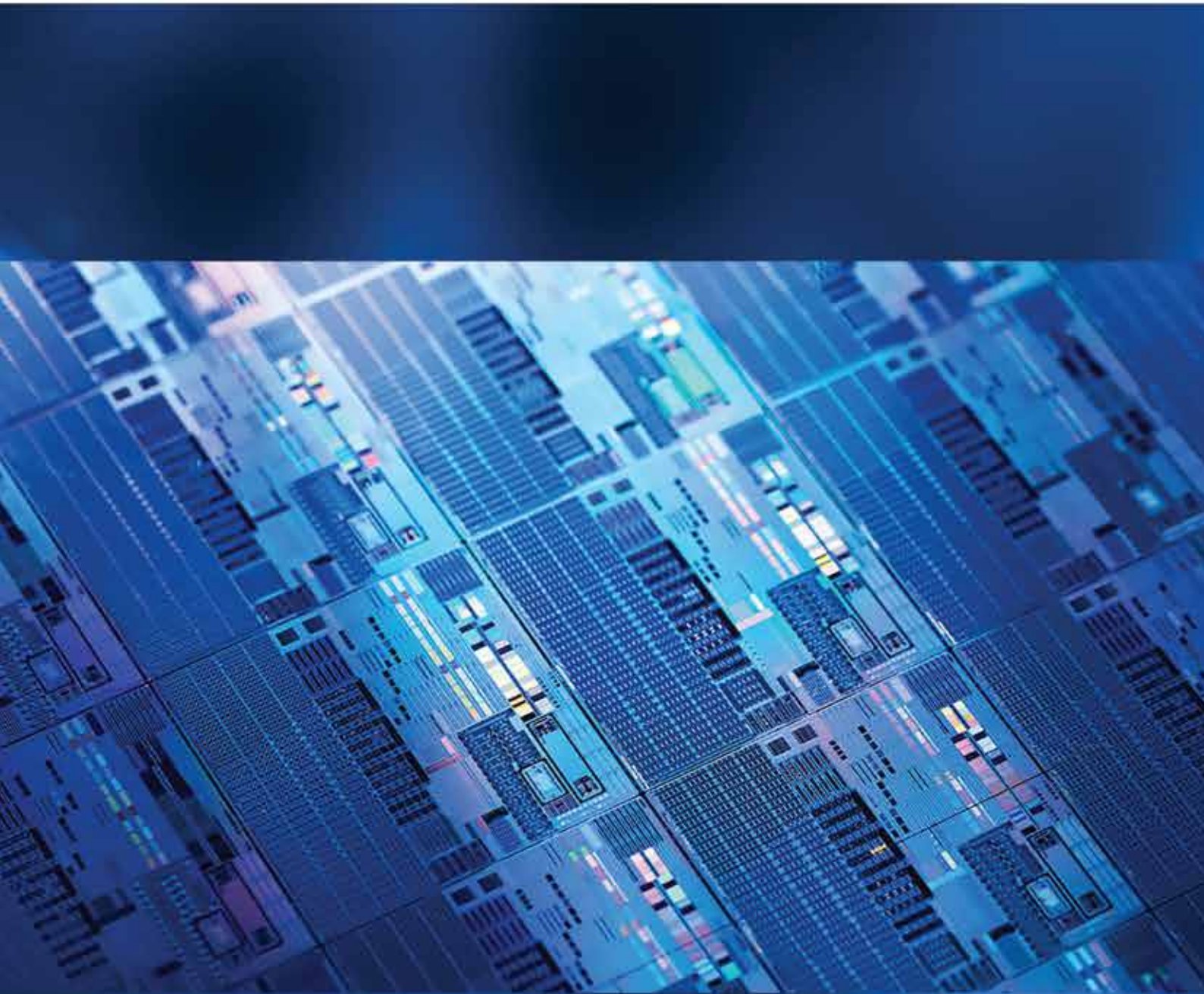
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